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This listing of claims will replace all prior versions of claims in the application.

Claims 1-36. (cancelled)

Claim 37. (currently amended) A photoresist composition that comprises:

- (a) a photoacid generator compound; and
- (b) a polymer that comprises a hydroxyadamantyl moiety, a polymerized norhornene group and at least two distinct repeat units that each has a photoacid-labile group.
- Claim 38. (previously presented) The photoresist composition of claim 37 wherein the polymer comprises a lactone group.
- Claim 39. (previously presented) The photoresist composition of claim 37 wherein the polymer comprises polymerized acrylate groups that comprise one or more photoacid-labile moieties.
- Claim 40. (previously presented) The photoresist composition of claim 37 wherein the polymer comprises one or more nitrile moieties.

Claim 41. (cancelled)

- Claim 42. (previously presented) The photoresist composition of claim 37 wherein the polymer is a terpolymer.
- Claim 43. (previously presented) The photoresist composition of claim 37 wherein the polymer is a tetrapolymer.

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- Claim 44. (previously presented) The photoresist of claim 37 wherein the polymer is substantially free of aromatic groups.
- Claim 45. (previously presented) The photoresist composition of claim 37 wherein the polymer is completely free of aromatic groups.
- Claim 46. (previously presented) A microelectronic wafer substrate having coated thereon a layer of the photoresist composition of claim 37.
  - Claim 47. (new) A photoresist composition that comprises:
  - (a) a photoacid generator compound; and
- (b) a polymer that comprises a hydroxyadamantyl moiety, a polymerized norbornene group and a lactone group.
- Claim 48. (new) The photoresist composition of claim 47 wherein the polymer is at least substantially free of aromatic groups.
- Claim 49. (new) The photoresist composition of claim 47 wherein the polymer comprises polymerized acrylate groups that comprise one or more photoacid-labile moieties.
- Claim 50. (new) The photoresist composition of claim 47 wherein the polymer comprises one or more nitrile moieties.